

**FLYING**

# CR1215-500DP

## Silicon Controlled Rectifiers

Voltage 500 Volt  
Current 12 Ampere

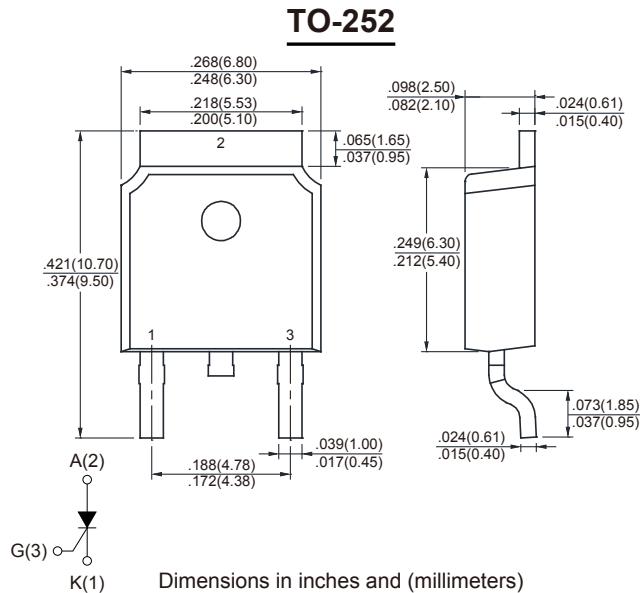
### MAIN FEATURES

Symbol	Value	Unit
I <sub>T(RMS)</sub>	12	A
V <sub>DRM/V<sub>RRM</sub></sub>	500	V
I <sub>GT</sub>	15	mA

### DESCRIPTION

The CR1215-500DP of silicon controlled rectifiers are specifically designed for medium power switching and phase control applications.

The glass passivation technology used has reliable operation up to 125°C junction temperature.



### ABSOLUTE MAXIMUM RATINGS

SYMBOL	PARAMETER	TEST CONDITIONS	VALUE	UNIT
V <sub>DRM</sub>	Repetitive peak off-state voltage	T <sub>J</sub> = 25 °C	500	V
V <sub>RRM</sub>	Repetitive peak reverse voltage	T <sub>J</sub> = 25 °C	500	V
I <sub>T(RMS)</sub>	RMS on-state current full sine wave	T <sub>C</sub> = 98 °C, 180° conduction angle	12	A
I <sub>TSM</sub>	Non repetitive surge peak on-state current	F=50Hz, t <sub>P</sub> =10ms, half full cycle, T <sub>J</sub> initial=25 °C	100	A
I <sup>2</sup> t	I <sup>2</sup> t Value for fusing	t <sub>P</sub> = 10 ms	50	A <sup>2</sup> s
I <sub>GM</sub>	Peak gate current		2	A
P <sub>G(AV)</sub>	Average gate power dissipation		0.5	W
P <sub>GM</sub>	Peak gate power		5	W
dI/dt	Critical rate of rise of on-state current	I <sub>G</sub> = 2×I <sub>GT</sub>	50	A/μs
T <sub>J</sub>	Operating junction temperature range		-40 to 125	°C
T <sub>STG</sub>	Storage temperature range		-40 to 150	°C

## ELECTRICAL SPECIFICATIONS ( $T_J = 25^\circ\text{C}$ unless otherwise specified)

SYMBOL	TEST CONDITIONS	VALUE	UNIT
$I_{GT}$	$V_D = 12\text{V}$ , $R_L = 100\Omega$	MAX	15
$V_{GT}$	$V_D = 12\text{V}$ , $R_L = 100\Omega$	MAX	1.5
$I_H$	$V_{AK} = 12\text{V}$ , $I_{GK} = 100\text{mA}$	MAX	20
$I_L$	$I_G = 1.2 \times I_{GT}$	MAX	40
$dV/dt$	$V_D = 67\% V_{DRM}$ , Gate open	$T_J = 125^\circ\text{C}$	MIN
			50
			$\text{V}/\mu\text{s}$

## STATIC CHARACTERISTICS

SYMBOL	TEST CONDITIONS	VALUE	UNIT
$V_{TM}$	$I_T = 23\text{A}$ , $t_P = 380\mu\text{s}$	$T_J = 25^\circ\text{C}$	1.75
$I_{DRM}, I_{RRM}$	$V_D = V_{DRM}$ , $V_R = V_{RRM}$	$T_J = 25^\circ\text{C}$	10
		$T_J = 125^\circ\text{C}$	0.5
			$\mu\text{A}$
			mA

## THERMAL RESISTANCE

SYMBOL	PARAMETER	VALUE	UNIT
$R_{\theta JC}$	Thermal resistance, junction to case	2.4	$^\circ\text{C}/\text{W}$

# RATINGS AND CHARACTERISTICS CURVES CR1215-500DP

Fig.1 - RMS on-state current versus case temperature

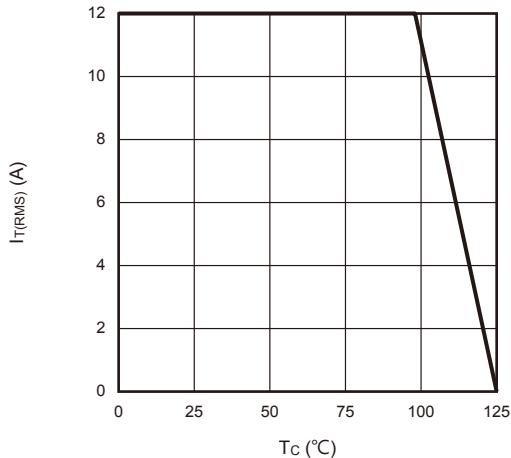


Fig.2 - Surge peak on-state current versus number of cycles

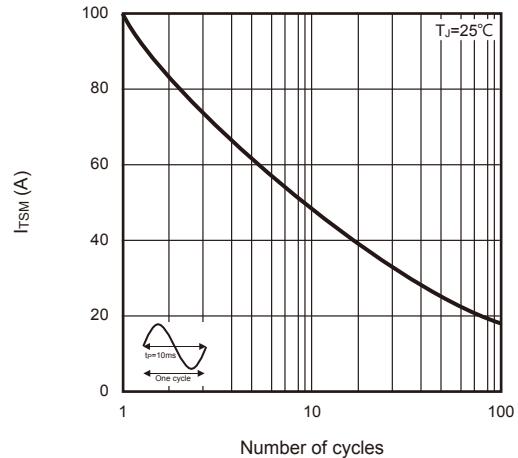


Fig.3 - On-state characteristics (maximum values)

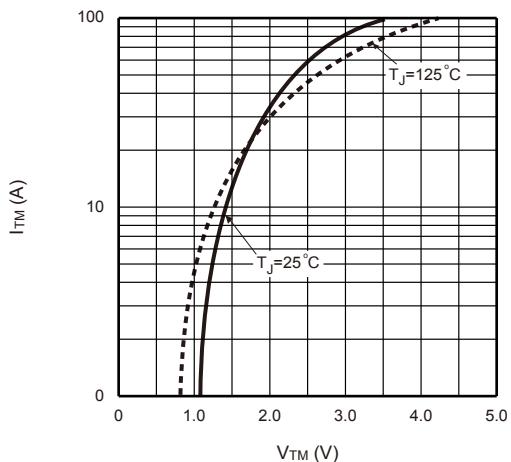


Fig.4 - Maximum power dissipation versus average on-state current

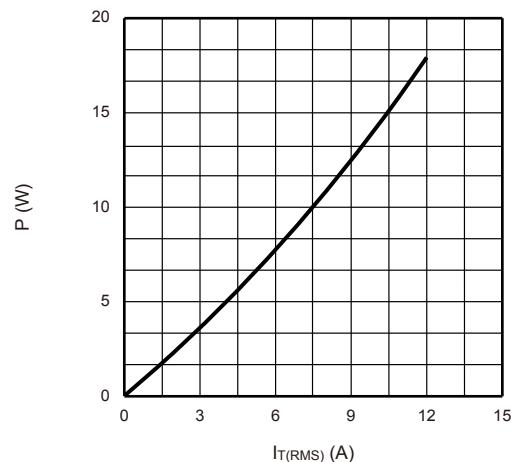


Fig.5 - Relative variations of gate trigger current, holding current and latching current versus junction temperature

